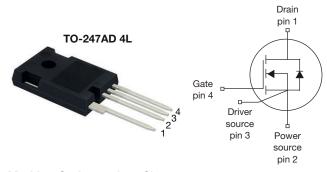


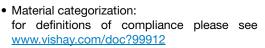
MaxSiC® 1200 V N-Channel SiC MOSFET



Marking Code: 120A063SL

FEATURES

- Fast switching speed
- Short circuit withstand time 3 µs





APPLICATIONS

- Solar inverters
- · Energy storage systems
- UPS (uninterruptible power supplies)

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	1200			
R _{DS(on)} typ. (mΩ) at 25 °C	V _{GS} = 18 V 63			
Q _g typ. (nC)	61			
I _D (A)	39			
C _{oss} typ. (pF)	70			
P _D (W)	205			
Configuration	Single			

ORDERING INFORMATION	
Package	TO-247AD 4L
Lead (Pb)-free and halogen-free	MXP120A063SL-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 ^{\circ}C$,	uniess otherwise	notea)			
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V_{DS}	1200		
Gate-source voltage		V_{GS}	-10 / +22	V	
Recommended operation voltage of gate-source		V_{GSOP}	-5 to -3 / +18		
Continuous drain current	T _C = 25 °C	I _D	39	^	
Pulsed drain current ^a		I _{DM}	78	Α	
Short-circuit withstand time ^b		T _{SC}	3	μs	
Maximum power dissipation	T _C = 25 °C	P _D	205	W	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak temperature)	For 10 s		260	°C	
Single pulse avalanche energy c	•	E _{AS}	162	mJ	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{GS} = 18 V, V_{DS} = 800 V, $R_{g(ext)}$ = 20 Ω , verified by the design / characterization
- c. $T_J = 25$ °C, $V_{DD} = 120$ V, L = 1 mH, $V_{GS} = 18$ V, $I_{AS} = 18$ A, verified by the design / characterization



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	40	°C/W	
Maximum junction-to-case (drain)	R _{thJC}	-	0.73	C/VV	

PARAMETER	SYMBOL	TEST CONDIT	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D =$	1 mA	1200	-	-	V
Onto a companie de la contra de	V	$V_{DS} = V_{GS}, I_D = 0$	3.5 mA	-	2.9	-	V
Gate-source threshold voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 3.5 \text{ m/s}$	$V_{DS} = V_{GS}$, $I_D = 3.5$ mA, $T_J = 175$ °C		2.0	-	V
Onto anima lankana		$V_{GS} = 22 \text{ V}, V_{DS}$	V _{GS} = 22 V, V _{DS} = 0 V		-	100	n^
Gate-source leakage	I _{GSS}	$V_{GS} = -10 \text{ V}, V_D$	_S = 0 V	-	-	-100	nA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 1200 V, V _O	_{GS} = 0 V	-	-	10	μA
		V _{GS} = 15 V, I _D = 18 A	-	75	94		
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 18 \text{ V}, I_D = 10 \text{ V}$	= 18 A	-	63	79	mΩ
		$V_{GS} = 18 \text{ V}, I_D = 18 \text{ A}$, T _J = 175 °C	-	107	-	
Transconductance	gfs	V _{DS} = 10 V, I _D =	= 18 A	-	7	-	S
Dynamic							
Input capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 800 V, f = 100 KHz		-	1909	-	pF
Output capacitance	C _{oss}			-	70	-	
Reverse transfer capacitance	C _{rss}			-	2	-	
Total gate charge	Q_g	$V_{GS} = -5 \text{ V} \sim 18 \text{ V}, I_D = 18 \text{ A}, V_{DS} = 800 \text{ V}$		-	61	-	nC
Gate-source charge	Q _{gs}			-	18	-	
Gate-drain charge	Q _{gd}			-	17	-	
Gate Resistance	R_g	V _{DS} = 0 V, f = 1 MHz		-	3	-	Ω
Switching Characteristics							
Town on delections	1		T _J = 25 °C	-	17	-	
Turn-on delay time	^T d(on)	$t_{d(on)}$ $T_{J} = 175 ^{\circ}C$	T _J = 175 °C	-	15	-	
Dia a tima			T _J = 25 °C	-	14	-	ns
Rise time	t _r		T _J = 175 °C	-	13	-	
To a finish the first			T _J = 25 °C	-	21	-	
Turn-off delay time	t _{d(off)}	$V_{GS} = -5 \text{ V} \sim 18 \text{ V},$	T _J = 175 °C	-	23	-	
Fall times		$I_D = 18 \text{ A}, V_{DS} = 800 \text{ V},$ $R_{q(ext)} = 4.4 \Omega$	T _J = 25 °C	-	10	-	
Fall time	t _f	1 (g(ext) = 4.4 22	T _J = 175 °C	-	10	-	
T	-		T _J = 25 °C	-	175	-	- μJ
Turn-on switching energy	E _{on}		T _J = 175 °C	-	151	-	
	_		T _J = 25 °C	-	57	-	
Turn-off switching energy	E _{off}		T _J = 175 °C	-	56	-	
Body Diode Ratings and Characteristic	<u> </u>						
Forward diode voltage	V _{SD}	V _{GS} = -5 V, I _{SD} = 9 A, T _J = 25 °C		-	4.8	-	٧
Continuous diode forward current	I _{SD}	V _{GS} = -5 V, T _J = 25 °C		-	-	29	<u> </u>
Pulsed diode forward current	I _{SDM}			-	-	78	Α
Reverse recovery time	t _{rr}	V _{GS} = -5 V, I _{SD} = 18 A, V _R = 800 V, di/dt = 1000 A/μs		-	18	-	ns
Reverse recovery charge	Q _{rr}			-	60	-	nC
Reverse recovery current	I _{RRM}			_	6	-	Α

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

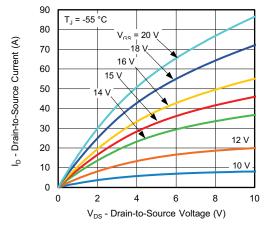


Fig. 1 - Typical Output Characteristics

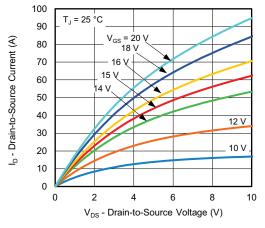


Fig. 2 - Typical Output Characteristics

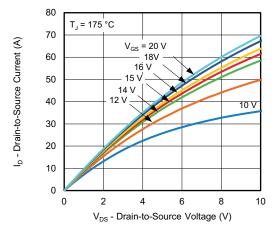


Fig. 3 - Typical Output Characteristics

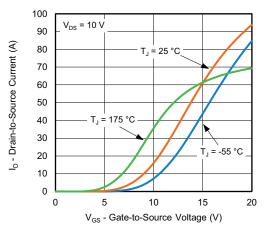


Fig. 4 - Typical Transfer Characteristics

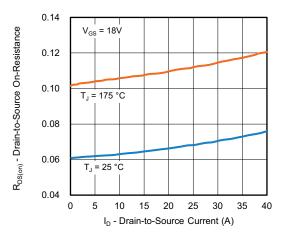


Fig. 5 - Normalized On-Resistance vs. Drain Current

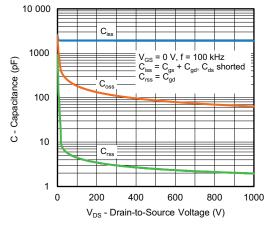


Fig. 6 - Typical Capacitance vs. Drain-to-Source Voltage



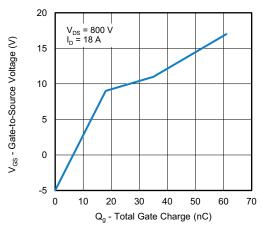


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

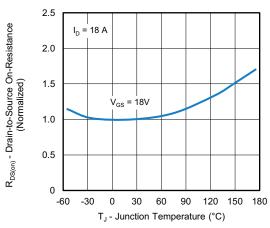


Fig. 8 - Normalized On-Resistance vs. Temperature

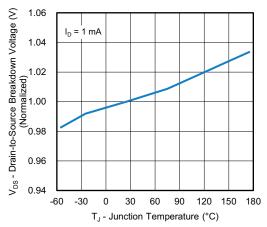


Fig. 9 - Drain-to-Source Voltage vs. Temperature

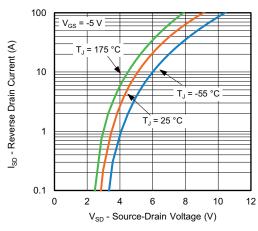


Fig. 10 - Typical Source-Drain Diode Forward Voltage

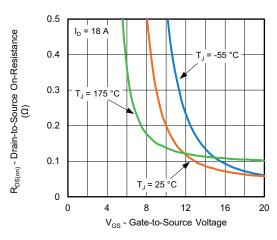


Fig. 11 - On-Resistance vs. Gate-to-Source Voltage

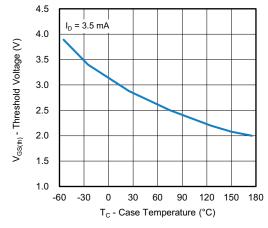


Fig. 12 - Threshold Voltage vs. Case Temperature

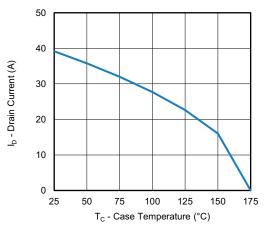


Fig. 13 - Drain Current vs. Case Temperature

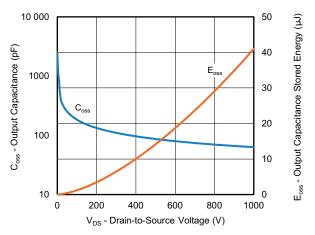


Fig. 14 - Output Capacitance and its Stored Energy vs.

Drain-to-Source Voltage

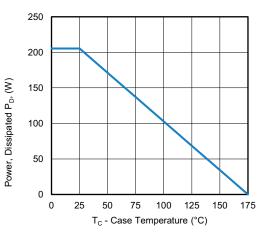


Fig. 15 - Power, Dissipated P_D vs. Case Temperature

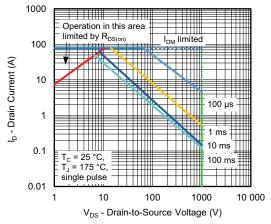


Fig. 16 - Safe Operating Area

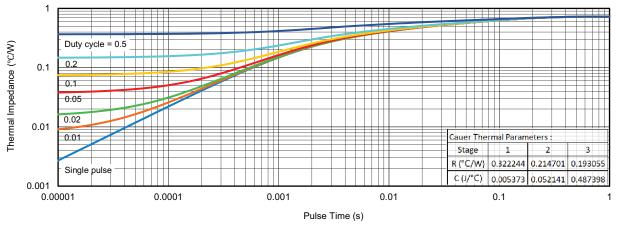


Fig. 17 - Transient Thermal Impedance



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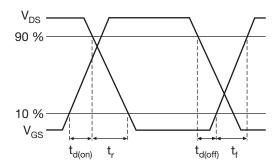


Fig. 18 - Waveforms of Switching Time

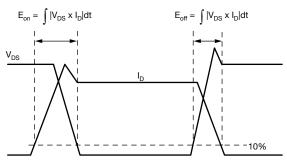


Fig. 19 - Waveforms for Switching Energy

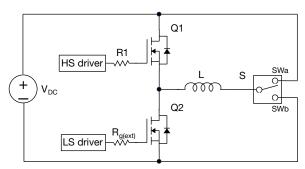


Fig. 20 - Switching and Reverse Diode Characteristics Measurement Circuit

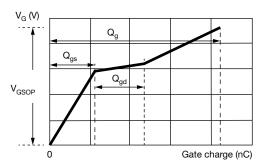


Fig. 21 - Waveforms for Gate Charge

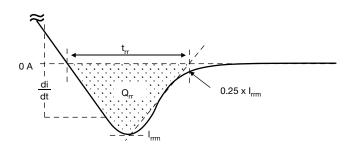


Fig. 22 - Waveforms for Reverse Recovery

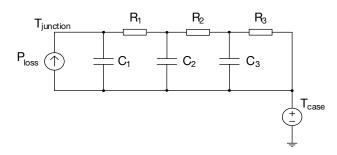


Fig. 23 - Thermal Equivalent Circuit

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